

BC213L

PNP General Purpose Amplifier

- This device is deisgned for use as general purpose amplifiers and switches requiring collector currents to 300mA.
- Sourced from process 68.
- See PN200 for Characteristics.



1. Emitter 2. Collector 3. Base

Absolute Maximum Ratings* T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	-30	V
V _{CBO}	Collector-Base Voltage	-45	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
I _C	Collector Current (DC) Continuous	-500	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Electrical Characteristics T_C=25°C unless otherwise noted

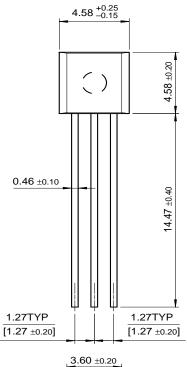
Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characte	eristics	•			
V _{(BR)CEO}	Collector-Emitter Voltage	$I_{C} = -2mA, I_{B} = 0$	-30		V
V _{(BR)CBO}	Collector-Base Voltage	$I_{C} = -10\mu A, I_{E} = 0$	-45		V
V _{(BR)EBO}	Emitter-Base Voltage	$I_E = -10\mu A, I_C = 0$	-5.0		V
I _{CBO}	Collector Cut-off Current	V _{CB} = -30V, I _E = 0		-15	nA
I _{EBO}	Emitter Cut-off Current	$V_{EB} = -4.0V, I_{C} = 0$		-15	nA
On Characte	eristics *	•			
h _{FE}	DC Current Gain	$V_{CE} = -5V, I_{C} = -10\mu A$ $V_{CE} = -5V, I_{C} = -2.0mA$	40 80	400	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_C = -10 \text{mA}, I_B = -0.5 \text{mA}$ $I_C = -100 \text{mA}, I_B = -5.0 \text{mA}$		-0.25 -0.6	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C = -100mA, I _B = -5.0mA		-1.1	V
V _{BE} (on)	Base-Emitter On Voltage	$V_{CE} = -5.0V, I_{C} = -2.0mA$	-0.6	-0.72	V
Small Signa	I Characteristics		•	•	
f _T	Current gain Bandwidth Product	$V_{CE} = -5.0V, I_{C} = -10mA$ f = 100MHz	200		MHz
NF	Noise Figure	$V_{CE} = -5.0V, I_{C} = -200\mu A$ $R_{G} = 2.0k\Omega, f = 1.0KHz$		10	dB
h _{fe}	Small Signal Current Gain	$I_C = -2.0 \text{mA}, V_{CE} = -5.0 \text{V}$ f = 1.0KHz	80		

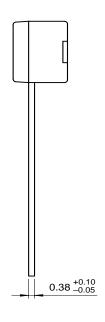
^{*} Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

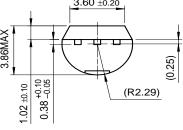
Thermal Characteristics T _A =25°C unless otherwise noted			
Symbol	Parameter	Max.	Units
P_{D}	Total Device Dissipation Derate above 25°C	625 5.0	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	°C/W

Package Dimensions

TO-92







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